

Small Signal Diode

BAS35

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise noted)

| Symbol | | Ratings | Unit | |
|--------------------|------------------------------------|-------------------------------|----------------|----|
| V_{RRM} | Maximum Repetitive Reverse Voltage | | 120 | V |
| I _{F(AV)} | Average Rectified | 200 | mA | |
| I _{FSM} | Non-Repetitive Peak Forward | Pulse Width = 1.0 second | 1.0 | Α |
| | Surge Current | Pulse Width = 1.0 microsecond | 2.0 | |
| T _{STG} | Storage Temperature Range | | -55 to +150 | °C |
| TJ | Operating Junction Temperature | | 150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. These ratings are based on a maximum junction temperature of 150 $^{\circ}\text{C}.$
- These are steady-state limits. The factory should be consulted on applications involving pulsed or low- duty-cycle operations.

THERMAL CHARACTERISTICS

| Symbol | Parameter | Ratings | Unit |
|-----------------|---|---------|------|
| P _D | Power Dissipation | 350 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | 357 | |



MARKING DIAGRAM



L22 = Specific Device Code M = Date Code

CONNECTION DIAGRAM



ORDERING INFORMATION

| Device | Package | Shipping [†] |
|--------|--|-----------------------|
| BAS35 | SOT-23 3L (Pb-Free, Halide Free) | 3000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------------|-----------------------|--|-----|------|------|
| V _R | Breakdown Voltage | I _R = 1.0 mA | 120 | - | V |
| V _F | Forward Voltage | I _F = 10 mA | - | 750 | mV |
| | | I _F = 50 mA | - | 840 | mV |
| | | I _F = 100 mA | - | 900 | mV |
| | | I _F = 200 mA | - | 1.0 | V |
| | | I _F = 400 mA | - | 1.25 | V |
| I _R | Reverse Current | V _R = 90 V | - | 100 | nA |
| | | V _R = 90 V, T _A = 150°C | - | 100 | μΑ |
| C _T | Total Capacitance | V _R = 0 , f = 1.0 MHz | - | 35 | pF |
| t _{rr} | Reverse Recovery Time | $I_F = I_R = 10$ mA, $I_{RR} = 1.0$ mA, $R_L = 100$ Ω | - | 50 | ns |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1



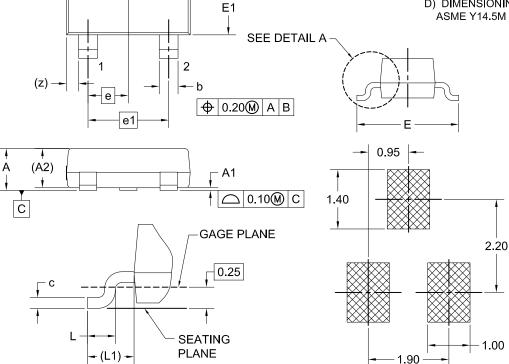


SOT-23 CASE 318BM ISSUE A

DATE 01 SEP 2021

NOTES: UNLESS OTHERWISE SPECIFIED

- A) REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE H.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE INCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M 2009.



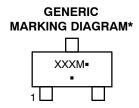
Α

В

| DIM | MILLIMETERS | | | |
|-----|-------------|------|------|--|
| DIM | MIN. | NOM. | MAX. | |
| Α | | | 1.20 | |
| A1 | 0.00 | 0.05 | 0.10 | |
| A2 | 0.93 REF | | | |
| b | 0.37 | 0.44 | 0.60 | |
| С | 0.08 | 0.15 | 0.23 | |
| D | 2.72 | 2.92 | 3.12 | |
| Е | 2.10 | 2.40 | 2.70 | |
| E1 | 1.15 | 1.30 | 1.50 | |
| е | 0.95 BSC | | | |
| e1 | 1.90 BSC | | | |
| L | 0.20 | | | |
| L1 | 0.55 REF | | | |
| z | 0.29 REF | | | |
| | | | | |

LAND PATTERN RECOMMENDATION

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.



DETAIL A

XXX = Specific Device Code
M = Date Code

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

| DOCUMENT NUMBER: | 98AON13784G | Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | | |
|------------------|-------------|---|-------------|--|
| DESCRIPTION: | SOT-23 | | PAGE 1 OF 1 | |

onsemi and ONSemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales